

## QUICKSWITCH<sup>®</sup> PRODUCTS HIGH-SPEED CMOS 12-BIT 3-TO-1 BUS-SELECT SWITCH

## **FEATURES:**

- Enhanced N channel FET with no inherent diode to Vcc
- Low propagation delay
- TTL-compatible input and output levels
- Undershoot clamp diodes on all switch and control pins
- Available in 56-pin SSOP Package

## **APPLICATIONS**

- Video, audio, graphics switching, muxing
- Hot-swapping, hot-docking
- Voltage translation (5V to 3.3V)

## **DESCRIPTION:**

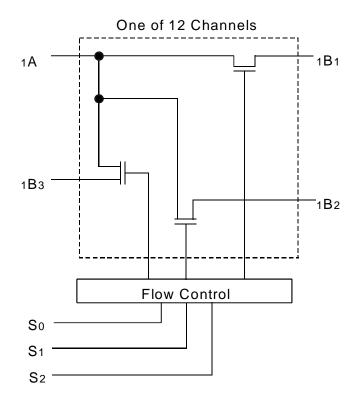
The QS3162214 provides a set of twelve high-speed CMOS TTLcompatible buses switching between three separate ports. The device operates as a 12-bit bus-select switch through the data-select (S0-S2) terminals.

The QS3162214 adds an internal  $25\Omega$  series termination resistor to reduce reflection noise in high speed applications. When closed, the switch acts as the source (series) termination for the driver connected to it.

Mux/Demux devices provide an order of magnitude faster speed than equivalent logic devices.

The QS3162214 is characterized for operation at -40°C to +85°C.

## **FUNCTIONAL BLOCK DIAGRAM**



### INDUSTRIAL TEMPERATURE RANGE

#### **NOVEMBER 1999**

## **PIN CONFIGURATION**

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So	1	$\bigcirc$	56	S1
1A	2		55	S2
1B3	3		54	1B1
2A	4		53	1B2
2B3	5		52	2B1
зА	6		51	2B2
зВз	7		50	3B1
GND	8		49	GND
4A	9		48	3B2
4B3	10		47	4B1
5A	11		46	4B2
5 <b>B</b> 3	12		45	5B1
6A	13		44	5B2
6B3	14	SO56-1	43	6B1
7A	15		42	6B2
7B3	16		41	7B1
Vcc	17		40	7B2
8A	18		39	8B1
GND	19		38	GND
8B3	20		37	8B2
9A	21		36	9B1
9B3	22		35	9B2
10A	23		34	10B1
10 <b>B</b> 3	24		33	10B2
11A	25		32	11B1
11 <b>B</b> 3	26		31	11B2
12A	27		30	12B1
12B3	28		29	12B2

SSOP TOP VIEW

#### INDUSTRIALTEMPERATURERANGE

## **ABSOLUTE MAXIMUM RATINGS**<sup>(1)</sup>

Symbol	Description	Max.	Unit
VTERM <sup>(2)</sup>	Supply Voltage to Ground	– 0.5 to +7	۷
VTERM <sup>(3)</sup>	DC Switch Voltage Vs	– 0.5 to +7	۷
VTERM <sup>(3)</sup>	DC Input Voltage VIN	– 0.5 to +7	۷
VAC	AC Input Voltage (pulse width ≤20ns)	-3	۷
Ιουτ	DC Output Current	120	mA
Рмах	Maximum Power Dissipation (TA = 85°C)	.93	W
Tstg	Storage Temperature	- 65 to +150	°C

#### NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc Terminals.

3. All terminals except Vcc.

# CAPACITANCE

(TA = +25°C, f = 1.0MHz, VIN = 0V, VOUT = 0V)

Pins		Тур.	Max. <sup>(1)</sup>	Unit
Control Inputs		5	5.5	pF
Quickswitch Channels	Demux	10	12	pF
(Switch OFF)	Mux	6	7	pF

NOTE:

1. This parameter is guaranteed but not production tested.

### **PIN DESCRIPTION**

Pin Names	I/O	Description
1 <b>A</b> - 12 <b>A</b>	I/O	Bus A
1Bn - 12Bn	I/O	Bus B
S0 - S2	I	Data Select

### **FUNCTION TABLE(1)**

S2	<b>S</b> 1	S0	хА	Function
L	L	L	Z	Disconnect
L	L	Н	xB1	xA to xB1
L	Н	L	xB2	xA to xB2
L	Н	Н	Z	Disconnect
Н	L	L	Z	Disconnect
Н	L	Н	xВз	xA to xB3
Н	Н	L	xB1	xA to xB1
Н	Н	Н	xB2	xA to xB2

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level Z = High-Impedence

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40°C to +85°C, Vcc =  $5.0V \pm 10\%$ 

Symbol	Parameter	Test Conditions	Min.	Тур. <sup>(1)</sup>	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HIGH for Control Pins	2	—	_	V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Pins	-	_	0.8	V
lin	Input Leakage Current (Control Inputs)	$0V \le VIN \le Vcc$	-	_	±1	μA
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le VCC$	_	-	±1	μA
Ron	Switch On Resistance <sup>(2)</sup>	Vcc = Min., VIN = 0V, ION = 30mA	22	30	42	Ω
Ron	Switch On Resistance <sup>(2)</sup>	Vcc = Min., VIN = 2.4V, ION = 15mA	22	37	50	Ω
Vp	Pass Voltage <sup>(3)</sup>	$VIN = Vcc = 5V$ , $IOUT = -5\mu A$	3.7	4	4.2	V

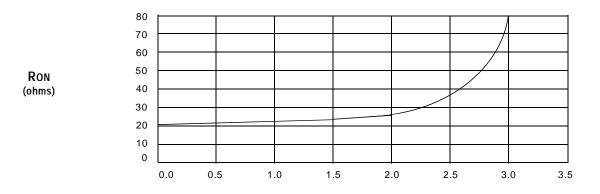
NOTES:

1. Typical values are at Vcc = 5.0V, TA =  $25^{\circ}$ C.

2. Max value of  $\mathsf{Ro}{\scriptscriptstyle\mathsf{N}}$  is guaranteed but not production tested.

3. Pass voltage is guaranteed but not production tested.

## TYPICAL ON RESISTANCE vs Vin AT Vcc = 5V





## **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Max.	Unit
Icco	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0	3	μA
ΔΙcc	Power Supply Current per Control Input HIGH <sup>(2)</sup>	Vcc = Max., VIN = 3.4V, f = 0	2.5	mA
ICCD	Dynamic Power Supply Current per MHz <sup>(3)</sup>	Vcc = Max., A and B pins open	0.25	mA/MHz
		Control Input Toggling at 50% Duty Cycle		

#### NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per TLL driven input (VIN = 3.4V, control inputs only). A and B pins do not contribute to ∆Icc.

3. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

# SWITCHING CHARACTERISTICS OVER OPERATING RANGE

#### $T_A = -40^{\circ}C \text{ to } +85^{\circ}C, V_{CC} = 5.0V \pm 10\%$

CLOAD = 50pF, RLOAD =  $500\Omega$  unless otherwise noted.

Symbol	Parameter	Min.	Тур. <sup>(1)</sup>	Max.	Unit
<b>t</b> PLH	Data Propagation Delay <sup>(2,4)</sup>	_	_	1.25 <sup>(3)</sup>	
<b>t</b> PHL	xA to xBn, xBn to xA				ns
tPZL	Switch Turn-on Delay	1.5	_	7.5	
<b>t</b> PZH	Sn to xA, xBn	1.5			ns
tPLZ	Switch Turn-off Delay <sup>(2)</sup>	1.5	_	5.8	
<b>t</b> PHZ	Sn to xA, xBn	1.0			ns

NOTES:

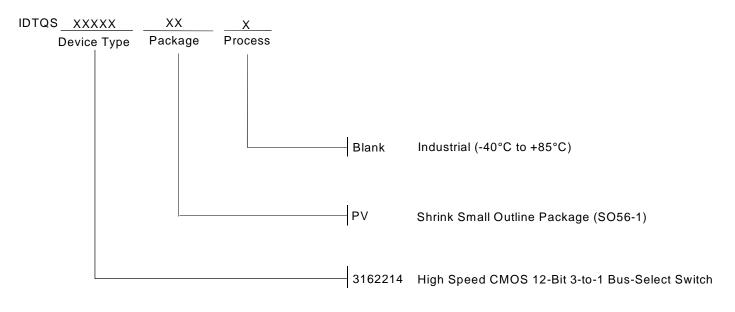
1. Minimums are guaranteed but not production tested.

2. This parameter is guaranteed but not production tested.

3. The time constant for the switch alone is of the order of 1.25ns for CL = 50pF.

4. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

### **ORDERING INFORMATION**





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